

C2D10120-Silicon Carbide Schottky Diode

ZERO RECOVERY® RECTIFIER

 $V_{RRM} = 1200 \text{ V}$

 $I_{\rm F} = 10 \text{ A}$

 $\mathbf{Q}_{c} = 61 \text{ nC}$

Features

- 1200-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

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Package

TO-220-2



Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor Drives

Part Number	Package	Marking	
C2D10120A	TO-220-2	C2D10120	

Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V _{RRM}	Repetitive Peak Reverse Voltage	1200	V		
V _{RSM}	Surge Peak Reverse Voltage	1200	V		
V _{DC}	DC Blocking Voltage	1200	V		
$I_{F(AVG)}$	Average Forward Current	10 22	А	T _c =160°C T _c =125°C	
$I_{\text{F(Peak)}}$	Peak Forward Current	25	А	T _c =125°C, T _{REP} <1 mS, Duty=0.5	
$I_{\sf FRM}$	Repetitive Peak Forward Surge Current	50	А	T_c =25°C, t_p =10 ms, Half Sine Wave	
I_{FSM}	Non-Repetitive Peak Forward Surge Current	250	А	$T_c=25$ °C, $t_p=10$ µs, Pulse	
P _{tot}	Power Dissipation	312 104	W	T _c =25°C T _c =125°C	
$T_{_{\mathtt{J}}}$, $T_{_{\mathtt{stg}}}$	Operating Junction and Storage Temperature	-55 to +175	°C		
	TO-220 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	



Electrical Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V _F	Forward Voltage	1.6 2.5	1.8 3.0	V	I _F = 10 A T _J =25°C I _F = 10 A T _J =175°C	
I _R	Reverse Current	10 20	200 1000	μΑ	$V_R = 1200 \text{ V } T_J = 25^{\circ}\text{C}$ $V_R = 1200 \text{ V } T_J = 150^{\circ}\text{C}$	
Q _c	Total Capacitive Charge	61		nC	$V_R = 1200 \text{ V, } I_F = 10 \text{ A}$ $di/dt = 500 \text{ A/}\mu\text{s}$ $T_J = 25^{\circ}\text{C}$	
С	Total Capacitance	1000 80 59		pF	$V_R = 0 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 200 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 400 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$	

Note

Thermal Characteristics

Symbol	Parameter	Тур.	Unit
$R_{_{ heta JC}}$	Thermal Resistance from Junction to Case	0.48	°C/W

Typical Performance

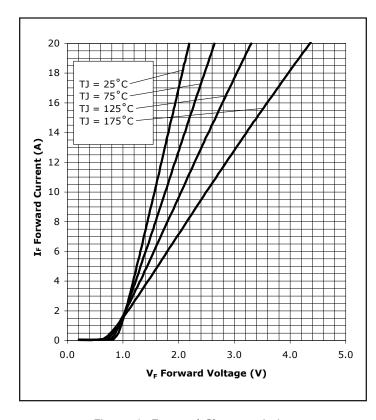


Figure 1. Forward Characteristics

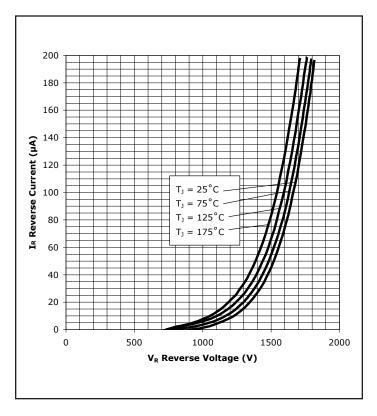
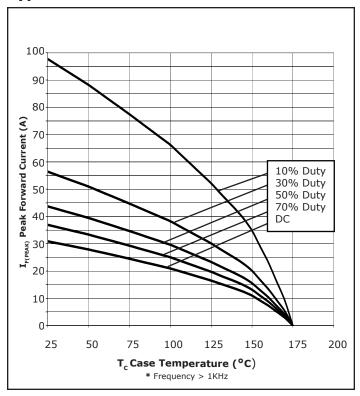


Figure 2. Reverse Characteristics

^{1.} This is a majority carrier diode, so there is no reverse recovery charge.



Typical Performance



800
700
600
400
200
100
100
100
V_R Reverse Voltage (V)

Figure 3. Current Derating

Figure 4. Capacitance vs. Reverse Voltage

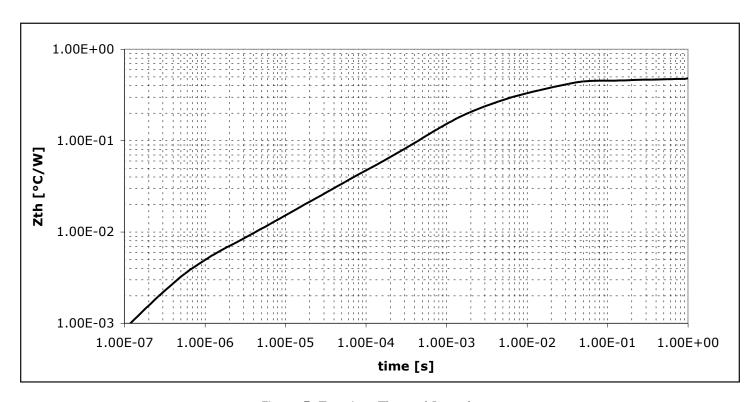
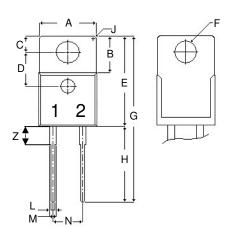


Figure 5. Transient Thermal Impedance

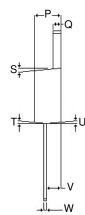


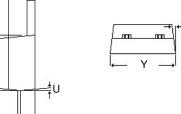
Package Dimensions

Package TO-220-2



O CASE







POS	Inc	hes	Millimeters		
PUS	Min	Max	Min	Max	
А	.381	.410	9.677	10.414	
В	.235	.255	5.969	6.477	
С	.100	.120	2.540	3.048	
D	.223	.337	5.664	8.560	
Е	.590	.615	14.986	15.621	
F	.143	.153	3.632	3.886	
G	1.105	1.147	28.067	29.134	
Н	.500	.550	12.700	13.970	
J	R 0.	197	R 0.197		
L	.025	.036	.635	.914	
М	.045	.055	1.143	1.397	
N	.195	.205	4.953	5.207	
Р	.165	.185	4.191	4.699	
Q	.048	.054	1.219	1.372	
S	3°	6°	3°	6°	
Т	3°	6°	3°	6°	
U	3°	6°	3°	6°	
V	.094	.110	2.388	2.794	
W	.014	.025	.356	.635	
Х	3°	5.5°	3°	5.5°	
Y	.385	.410	9.779	10.414	
Z	.130	.150	3.302	3.810	

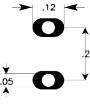
NOTE:
1. Dimension L, M, W apply for Solder Dip Finish

PIN 1O-

PIN 2 O-



Recommended Solder Pad Layout



TO-220-2

Part Number	Package	Marking		
C2D10120A	TO-220-2	C2D10120		

"The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006."

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, air traffic control systems, or weapons systems.

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